

STARPOWER

SEMICONDUCTOR

IGBT

GD600CUY65C2S

650V/600A chopper in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

Features

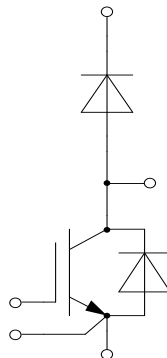
- Low $V_{CE(sat)}$ Trench IGBT technology
- 6 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted**IGBT**

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	650	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$	697	A
	@ $T_C=50^{\circ}\text{C}$	600	
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	1200	A
P_D	Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$	1630	W

Diode

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	650	V
I_F	Diode Continuous Forward Current	600	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	1200	A

Module

Symbol	Description	Value	Unit
T_{jmax}	Maximum Junction Temperature	175	$^{\circ}\text{C}$
T_{jop}	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}$, $t=1\text{min}$	4000	V

IGBT Characteristics $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit	
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=600\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.45	1.90	V	
		$I_C=600\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		1.60			
		$I_C=600\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$		1.70			
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=9.60\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.1	5.8	6.5	V	
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			5.0	mA	
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA	
R_{Gint}	Internal Gate Resistance			0.68		Ω	
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$		35.1		nF	
C_{res}	Reverse Transfer Capacitance				1.04		nF
Q_G	Gate Charge	$V_{GE}=-15 \dots +15\text{V}$		5.85		μC	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300\text{V}, I_C=600\text{A}, R_G=2.4\Omega, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$		80		ns	
t_r	Rise Time			72		ns	
$t_{d(off)}$	Turn-Off Delay Time			402		ns	
t_f	Fall Time			60		ns	
E_{on}	Turn-On Switching Loss				5.34		mJ
E_{off}	Turn-Off Switching Loss				19.4		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300\text{V}, I_C=600\text{A}, R_G=2.4\Omega, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$		88		ns	
t_r	Rise Time			76		ns	
$t_{d(off)}$	Turn-Off Delay Time			426		ns	
t_f	Fall Time			64		ns	
E_{on}	Turn-On Switching Loss				5.94		mJ
E_{off}	Turn-Off Switching Loss				22.5		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300\text{V}, I_C=600\text{A}, R_G=2.4\Omega, V_{GE}=\pm 15\text{V}, T_j=150^\circ\text{C}$		96		ns	
t_r	Rise Time			80		ns	
$t_{d(off)}$	Turn-Off Delay Time			438		ns	
t_f	Fall Time			64		ns	
E_{on}	Turn-On Switching Loss				6.30		mJ
E_{off}	Turn-Off Switching Loss				23.9		mJ
I_{SC}	SC Data	$t_p \leq 6\mu\text{s}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}, V_{CC}=360\text{V}, V_{CEM} \leq 650\text{V}$		3000		A	

Diode Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit		
V_F	Diode Forward Voltage	$I_C=600\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$		1.55	2.00	V		
		$I_C=600\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$		1.50				
		$I_C=600\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$		1.45				
Q_r	Recovered Charge	$V_R=300\text{V}, I_F=600\text{A},$ $-di/dt=6600\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=25^\circ\text{C}$		18.7		μC		
I_{RM}	Peak Reverse Recovery Current			226		A		
E_{rec}	Reverse Recovery Energy			4.4		mJ		
Q_r	Recovered Charge	$V_R=300\text{V}, I_F=600\text{A},$ $-di/dt=6600\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=125^\circ\text{C}$		39.6		μC		
			I_{RM}	Peak Reverse Recovery Current		330		A
			E_{rec}	Reverse Recovery Energy		10.2		mJ
Q_r	Recovered Charge	$V_R=300\text{V}, I_F=600\text{A},$ $-di/dt=6600\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=150^\circ\text{C}$		46.2		μC		
			I_{RM}	Peak Reverse Recovery Current		363		A
			E_{rec}	Reverse Recovery Energy		11.6		mJ

Module Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
L_{CE}	Stray Inductance		15		nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal to Chip		0.25		m Ω
R_{thJC}	Junction-to-Case (per IGBT)			0.092	K/W
	Junction-to-Case (per Diode)			0.153	
R_{thCH}	Case-to-Heatsink (per IGBT)		0.022		K/W
	Case-to-Heatsink (per Diode)		0.037		
	Case-to-Heatsink (per Module)		0.010		
M	Terminal Connection Torque, Screw M6	2.5		5.0	N.m
	Mounting Torque, Screw M6	3.0		5.0	
G	Weight of Module		300		g

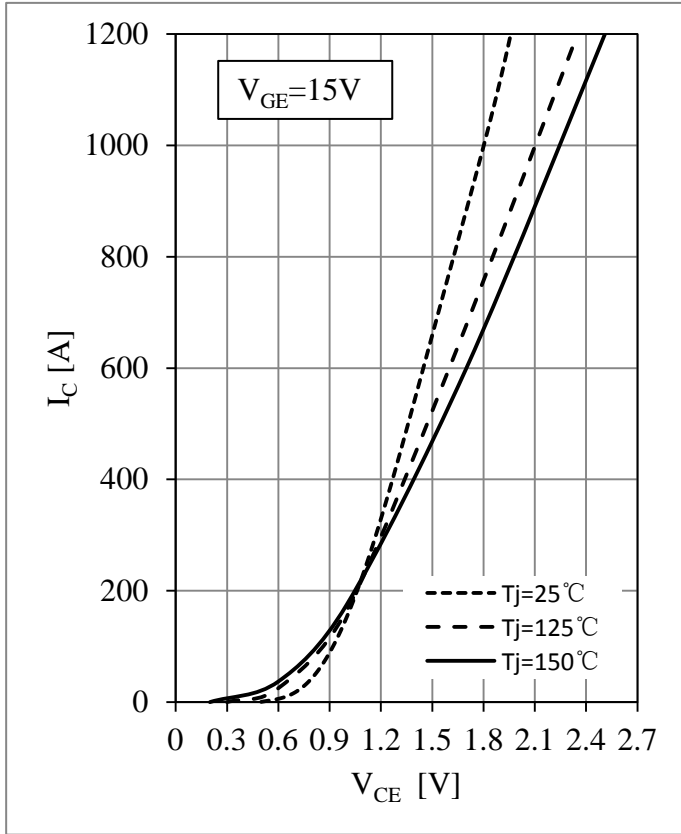


Fig 1. IGBT Output Characteristics

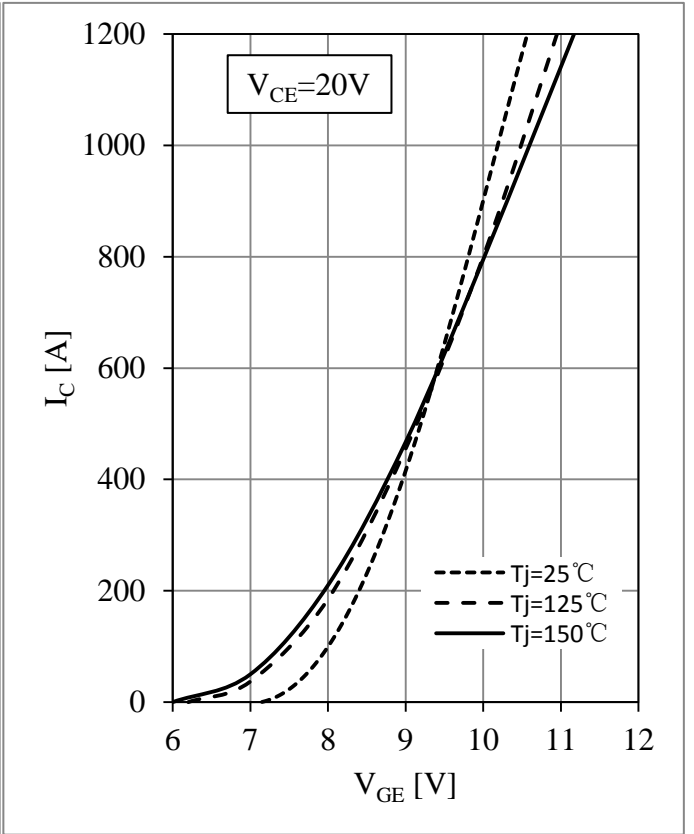


Fig 2. IGBT Transfer Characteristics

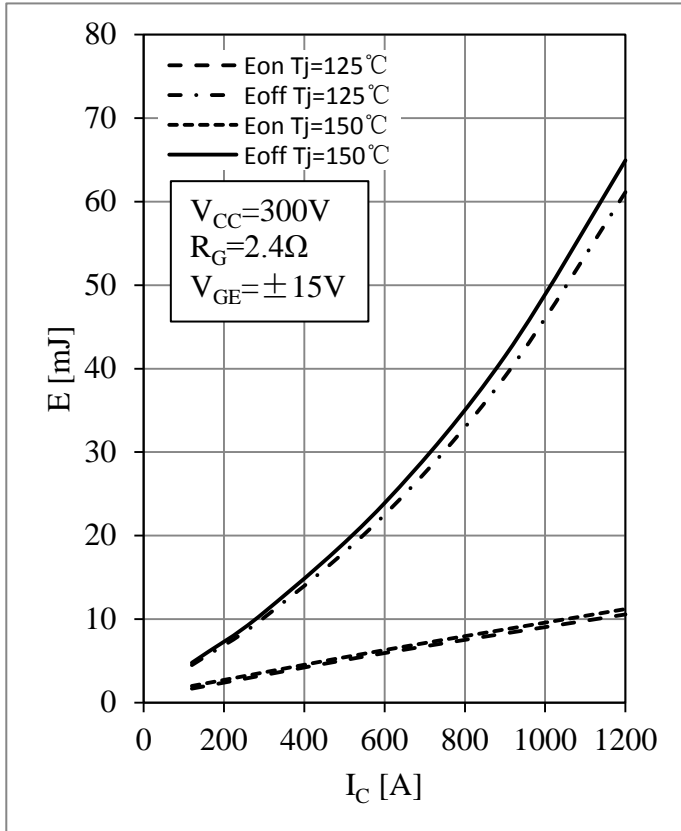


Fig 3. IGBT Switching Loss vs. I_C

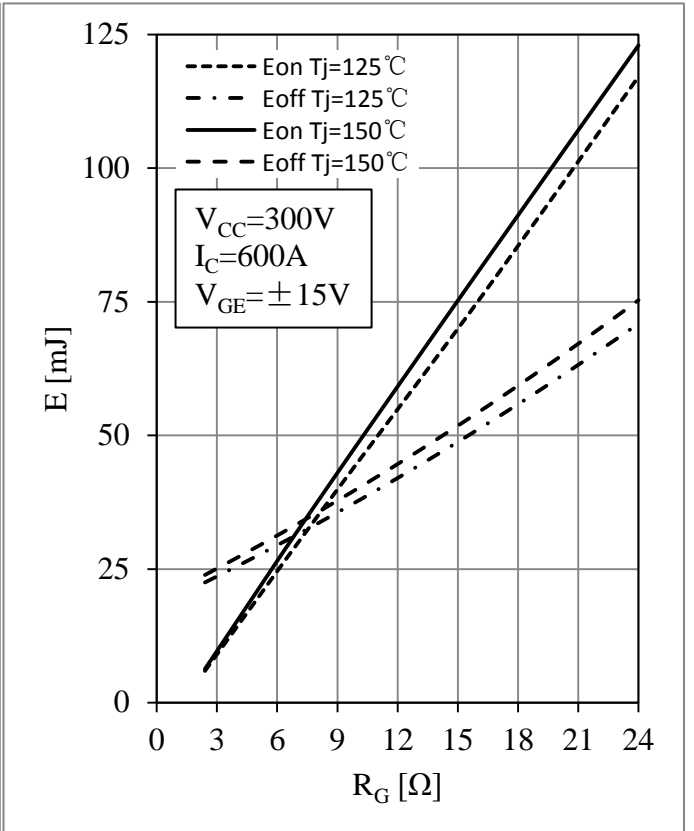


Fig 4. IGBT Switching Loss vs. R_G

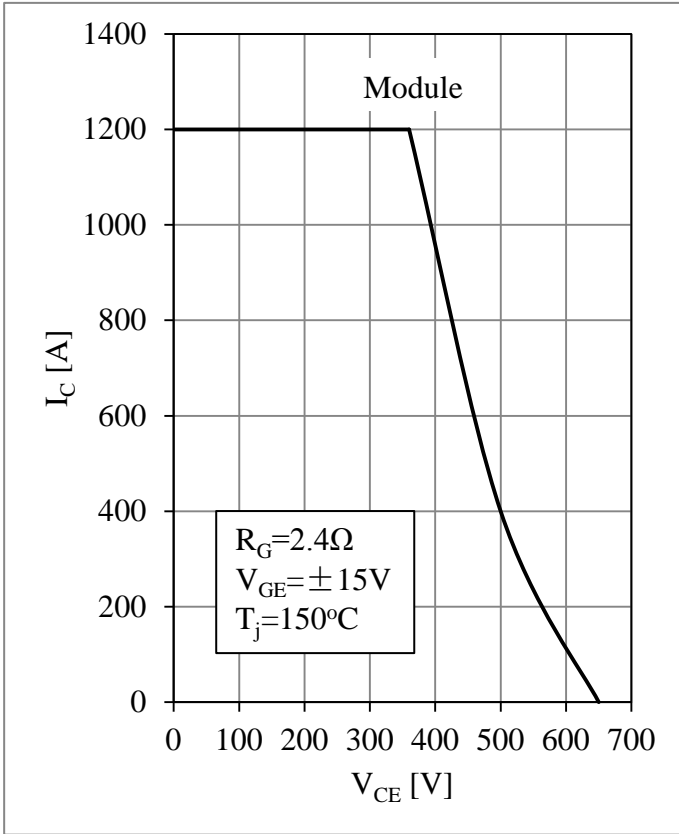


Fig 5. RBSOA

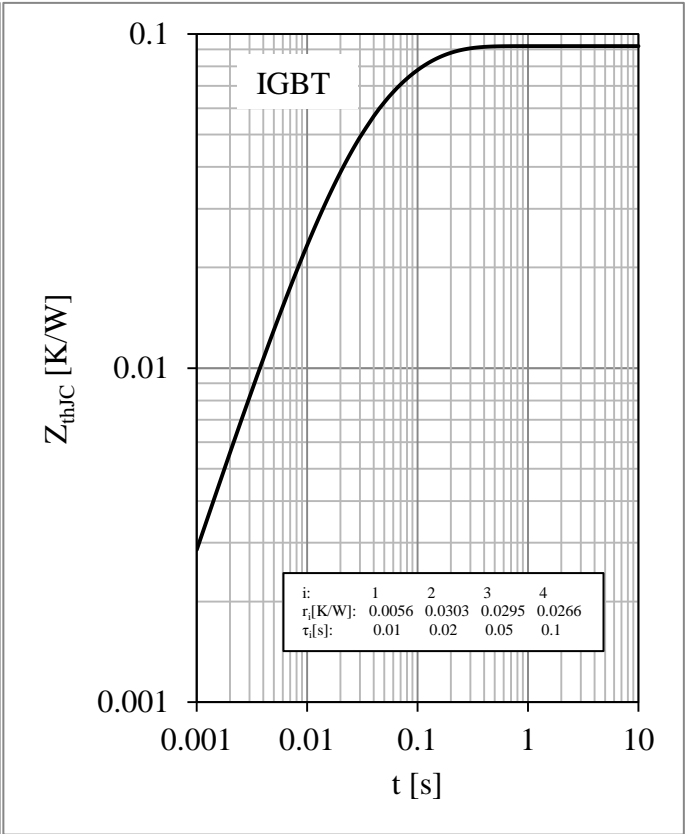


Fig 6. IGBT Transient Thermal Impedance

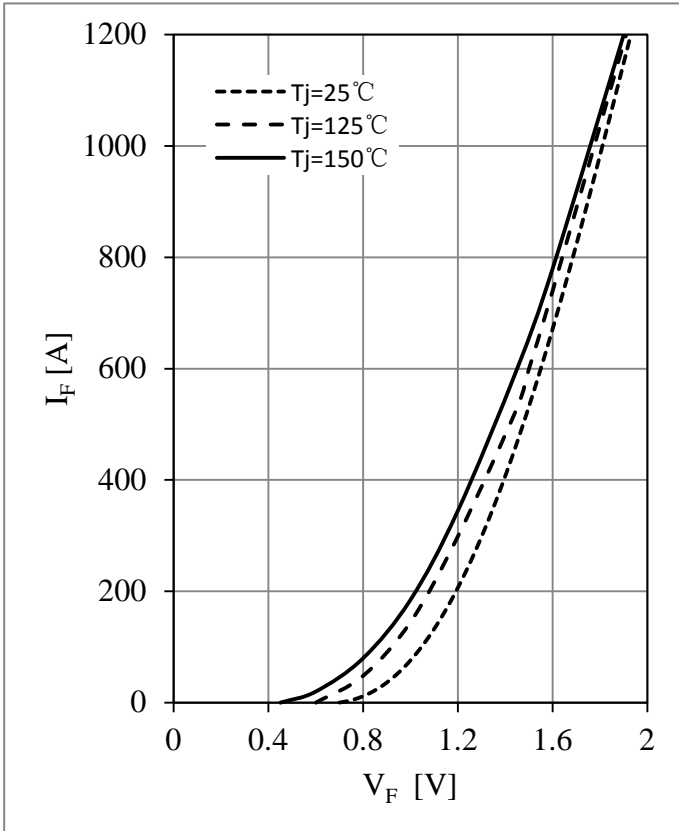


Fig 7. Diode Forward Characteristics

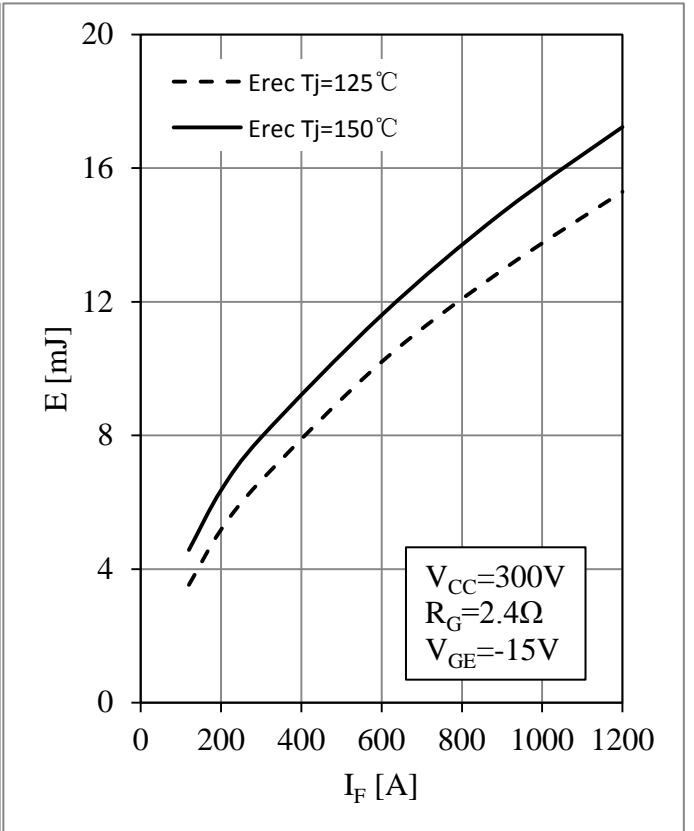


Fig 8. Diode Switching Loss vs. I_F

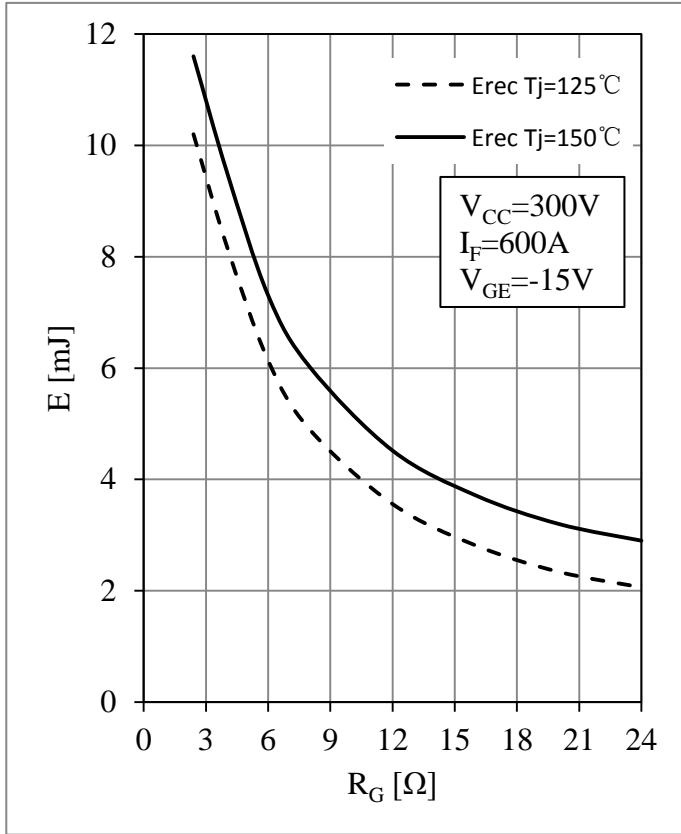


Fig 9. Diode Switching Loss vs. R_G

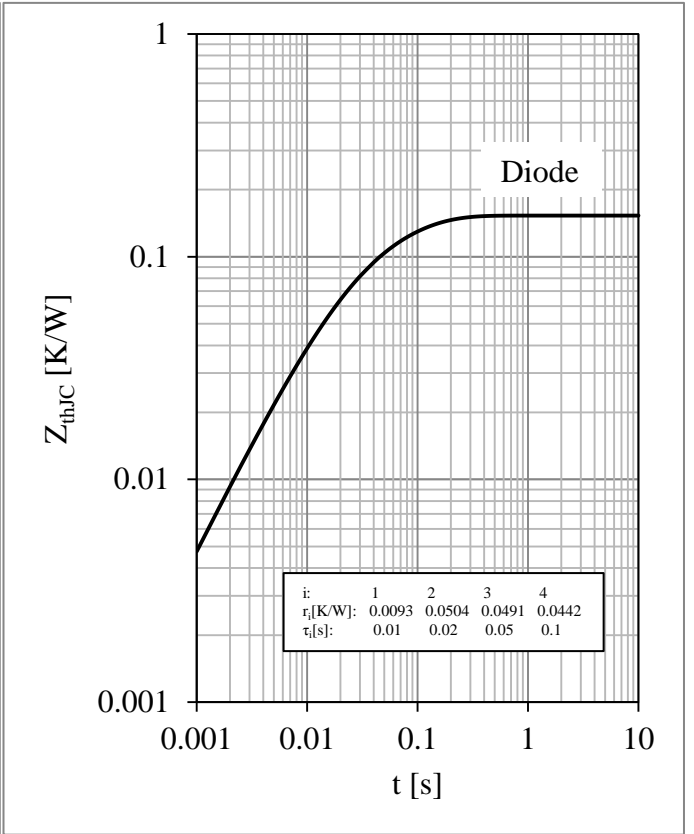
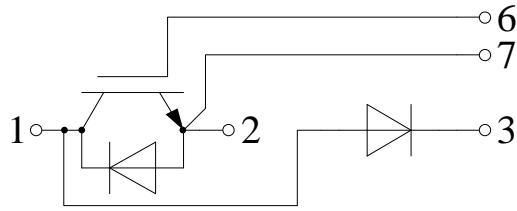


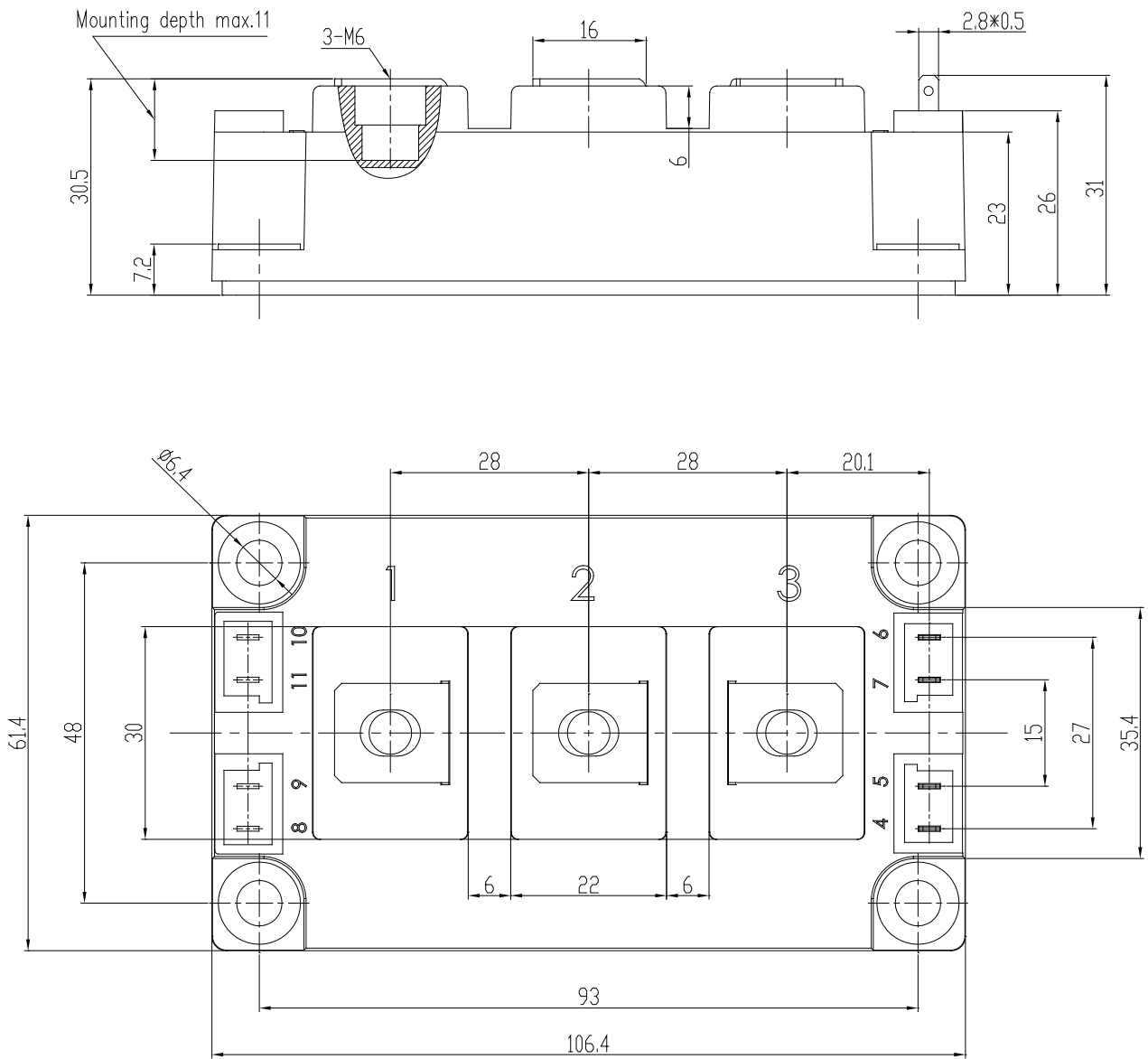
Fig 10. Diode Transient Thermal Impedance

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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